These assemblies are ESD sensitive, ESD precautions shall be observed.

These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

After verifying lens of A1 is clean and undistorted, snap cover H9 over sensor A1 during final hardware assembly.

**Components marked 'DNP' should not be populated.**

**Assembly Variant: 001**

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<th>PCB Viewed From Top Side</th>
<th>Board #: ISE4047</th>
<th>Rev: E1</th>
<th>Sun Rev: Not In VersionControl</th>
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<td>TID #: TIDA-00759</td>
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**Plot Name = Top Assembly Drawing**

**Generated:** 2/22/2016 10:26:20 AM

**Texas Instruments**
COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: 001

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<th>REV: E1</th>
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<td>PLOT NAME = Bottom Assembly Drawing</td>
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